



Update Notification

Document # : FPCN20930ZA1

Issue Date: 23 December 2016

Title of Change:	Update Notice to FPCN20930ZA - affected device list modification		
Proposed first ship date:	13 November 2017		
Contact information:	Contact your local ON Semiconductor Sales Office or < SitiNurhaza.MohdRamli@onsemi.com>		
Samples:	Contact your local ON Semiconductor Sales Office		
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or < cheanching.sim@onsemi.com >.		
Type of notification:	ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.		
Change category:	☒ Wafer Fab Change ☐ Assembly Change ☐ Test Change ☐ Other _____		
Change Sub-Category(s): ☐ Manufacturing Site Change/Addition ☐ Manufacturing Process Change ☒ Material Change ☐ Product specific change ☐ Datasheet/Product Doc change ☐ Shipping/Packaging/Marking ☐ Other: _____			
Sites Affected: ☒ All site(s) ☐ not applicable ☐ ON Semiconductor site(s) : ☐ External Foundry/Subcon site(s)			
Description and Purpose: FPCN20930ZA was previously released to qualify Power Schottky top metal and back metal change. This Update Notification announces to customers that the following Orderable Part Number (OPN's) will be removed from FPCN20930ZA: NRVB120ESFT1G NRVB120ESFT3G NRVB140ESFT1G NRVB140ESFT3G NRVB140SFT1G NRVB140SFT3G NRVB1H100SFT3G NRVB2H100SFT3G The remaining OPNs listed below in the List of Affected Standard Parts will be retained in FPCN20930ZA and subject to the announced top metal and back metal change.			
List of affected Standard Parts: NRVBAF3200T3G NRVBAF440T3G NRVBM110ET1G NRVBM120ET1G NRVBM120ET3G NRVBM140T1G NRVBM140T3G NRVBM2H100T3G			